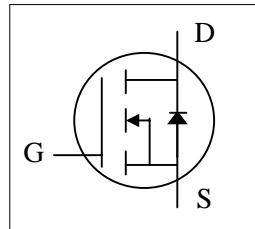
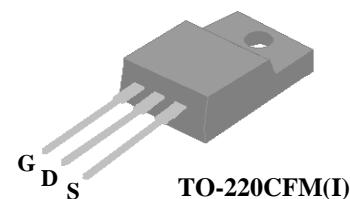




- ▼ Low On-resistance
- ▼ Simple Drive Requirement
- ▼ Fast Switching Characteristic



$BV_{DSS}$	500V
$R_{DS(ON)}$	0.62Ω
$I_D$	11A



## Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220CFM isolation package is widely preferred for commercial-industrial through hole applications.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	500	V
$V_{GS}$	Gate-Source Voltage	+30	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	11	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	5.6	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	40	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	40	W
$E_{AS}$	Single Pulse Avalanche Energy <sup>2</sup>	50	mJ
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Value	Units
$R_{thj-c}$	Maximum Thermal Resistance, Junction-case	3.2	°C/W
$R_{thj-a}$	Maximum Thermal Resistance, Junction-ambient	65	°C/W



## Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=1mA$	500	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>3</sup>	$V_{GS}=10V, I_D=6A$	-	-	0.62	$\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
$g_f$	Forward Transconductance	$V_{DS}=10V, I_D=6A$	-	9	-	S
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=400V, V_{GS}=0V$	-	-	100	$\mu A$
$I_{GSS}$	Gate-Source Leakage	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	$\pm 100$	$nA$
$Q_g$	Total Gate Charge <sup>3</sup>	$I_D=6A$	-	43	69	$nC$
$Q_{gs}$	Gate-Source Charge	$V_{DS}=400V$	-	8	-	$nC$
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	20	-	$nC$
$t_{d(on)}$	Turn-on Delay Time <sup>3</sup>	$V_{DD}=250V$	-	36	-	ns
$t_r$	Rise Time	$I_D=6A$	-	53	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=50\Omega, V_{GS}=10V$	-	230	-	ns
$t_f$	Fall Time	$R_D=42\Omega$	-	60	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	1680	2600	$pF$
$C_{oss}$	Output Capacitance	$V_{DS}=25V$	-	160	-	$pF$
$C_{rss}$	Reverse Transfer Capacitance	f=1.0MHz	-	15	-	$pF$

## Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{SD}$	Forward On Voltage <sup>3</sup>	$I_S=6A, V_{GS}=0V$	-	-	1.5	V
$t_{rr}$	Reverse Recovery Time <sup>3</sup>	$I_S=6A, V_{GS}=0V$	-	350	-	ns
$Q_{rr}$	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	5	-	$\mu C$

### Notes:

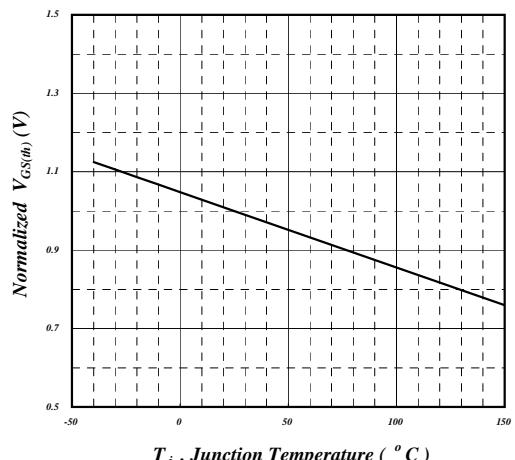
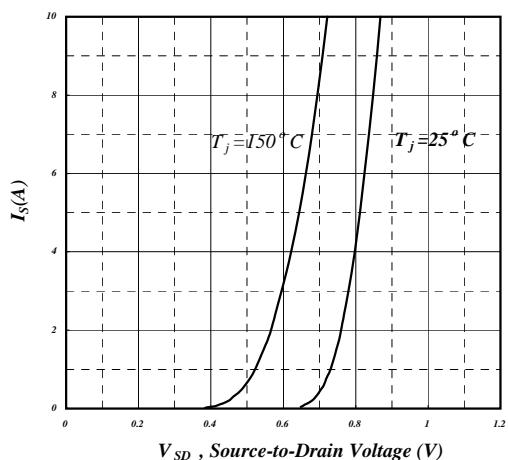
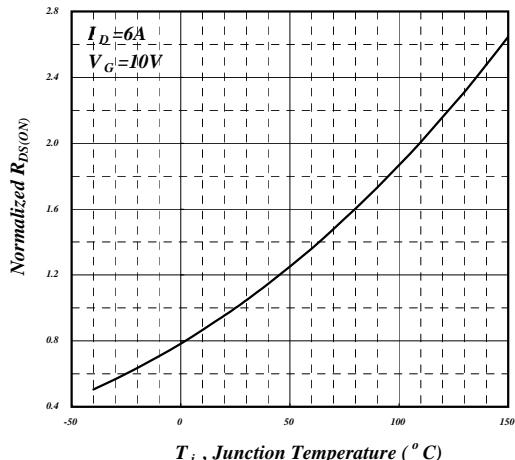
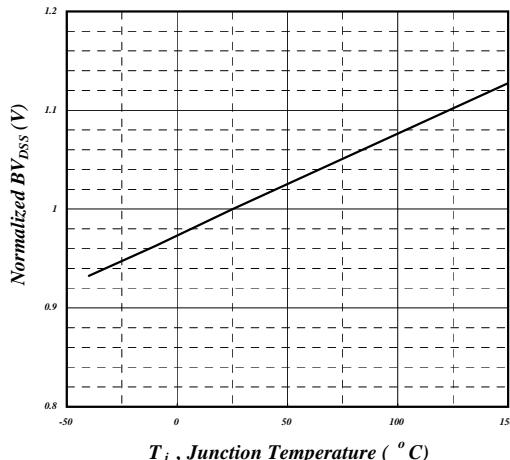
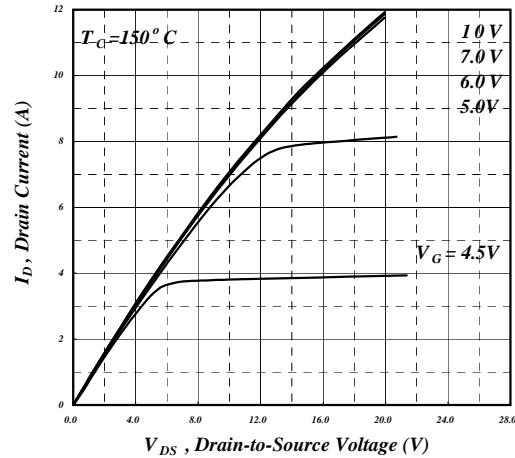
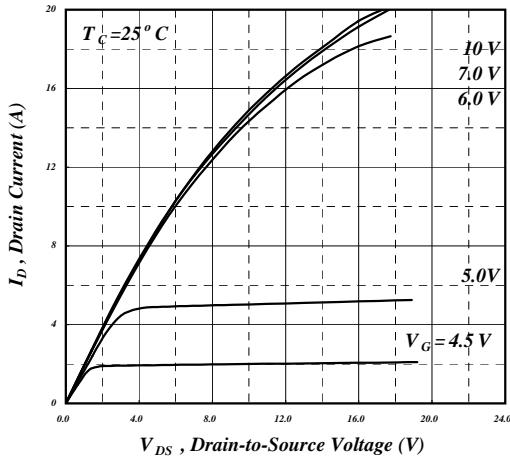
- 1.Pulse width limited by Max junction temperature.
- 2.Starting  $T_j=25^\circ C$  ,  $V_{DD}=50V$  ,  $L=1mH$  ,  $R_G=25\Omega$
- 3.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

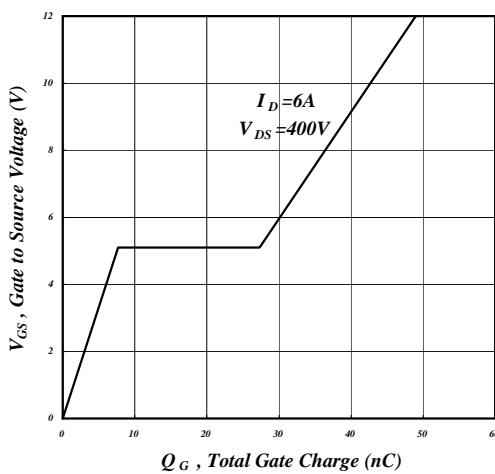
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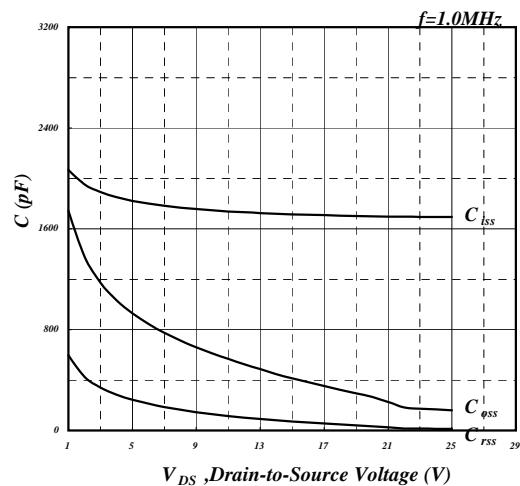




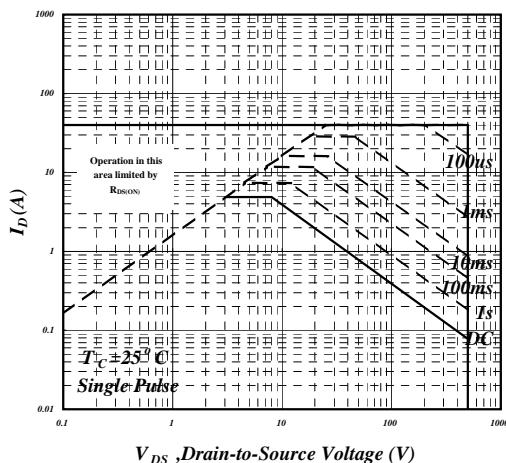
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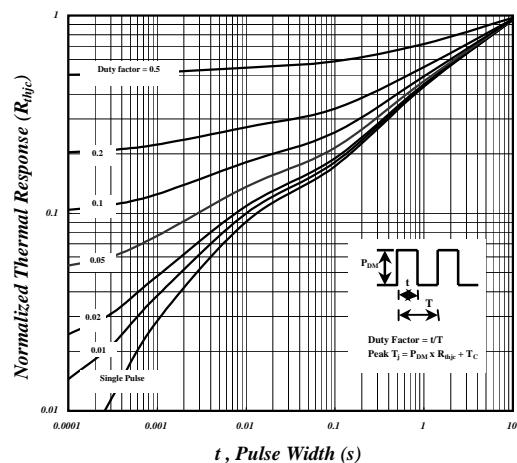
**Fig 7. Gate Charge Characteristics**



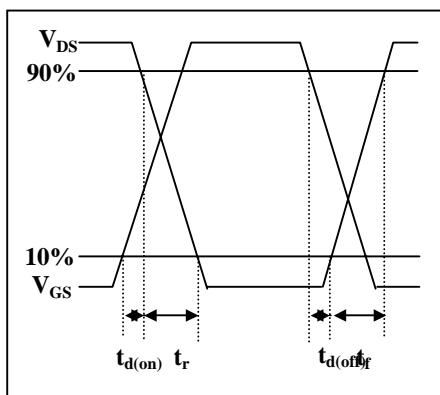
**Fig 8. Typical Capacitance Characteristics**



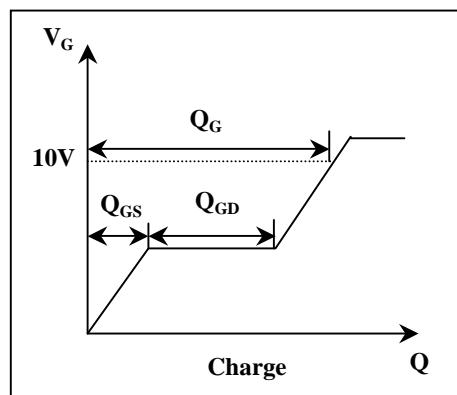
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**



**Fig 11. Switching Time Waveform**



**Fig 12. Gate Charge Waveform**